

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S2 series

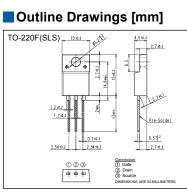
N-Channel enhancement mode power MOSFET

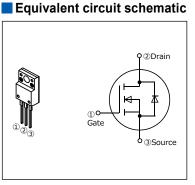
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

| Parameter | Symbol | Characteristics | Unit | Remarks |
|---|------------------|-----------------|-------|-----------------------------|
| Drain Source Veltere | V _{DS} | 600 | V | |
| Drain-Source Voltage | V _{DSX} | 600 | V | V _{GS} =-30V |
| Continuous Drain Current | lo | 23.9 | А | Tc=25°C Note*1,2 |
| Continuous Drain Current | | 15.1 | А | Tc=100°C Note*1,2 |
| Pulsed Drain Current | I _{DP} | 71.6 | А | Note *2 |
| Gate-Source Voltage | V _{GS} | ±30 | V | |
| Non-Repetitive Maximum Avalanche Current | las | 2.7 | А | Note *3 |
| Non-Repetitive Maximum Avalanche Energy | Eas | 618 | mJ | Note *4 |
| Maximum Drain-Source dV/dt | dV₀s/dt | 50 | V/ns | V _{DS} ≤ 600V |
| Continuous | 1 | 23.9 | А | Tc=25°C Note*1,2 |
| Diode Forward Current | I _{SD} | 15.1 | А | Tc=100°C Note*1,2 |
| Pulsed Diode Forward Current | ISDP | 71.6 | А | Note *2 |
| Peak Diode Recovery dV/dt | dV/dt | 15 | V/ns | Note *5 |
| Peak Diode Recovery -di/dt | -di/dt | 100 | A/µs | Note *6 |
| Maximum Davian Diagingtian | | 2.16 | 201 | <i>T</i> _a =25°C |
| Maximum Power Dissipation | PD | 45 | W | <i>T</i> c=25°C |
| Oneverting and Stevers Temperature range | Tch | 150 | °C | |
| Operating and Storage Temperature range | T _{stg} | -55 to +150 | °C | |
| Isolation Voltage (TO-220F) | Viso | 2 | kVrms | t=60sec,f=60Hz |

Note *1 : Maximum duty cycle D=0.65 Note *2 : Limited by maximum channel temperature. Note *3 : 7ch≤150°C, See Fig.1 and Fig.2 Note *4 : Starting 7ch=25°C, /ks=1.7A, L=392mH, Vob=60V, Rc=50Ω, See Fig.1 and Fig.2 Eas limited by maximum channel temperature and avalanche current.

Note *5 : IsoS17.9A, -di/dtS100A/µs, Vos peak≤600V, 7ch≤150°C. Note *6 : IsoS17.9A, dV/dt≤15V/ns, Vos peak≤600V, 7ch≤150°C.

Electrical Characteristics at Tc=25°C (unless otherwise specified) Static Ratings

| Parameter | Symbol | Conditions | | Min. | Тур. | Max. | Unit |
|----------------------------------|---------------------|---|-------------------------------|------|-------|-------|------|
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I₀=250µA | | 600 | - | - | V |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} I₀=0.95mA | | 3.5 | 4.0 | 4.5 | V |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} =600V V _{GS} =0V | T _{ch} =25°C | - | - | 25 | -μA |
| | | V _{DS} =480V V _{GS} =0V | <i>T</i> _{ch} =125°C | - | - | 250 | |
| Gate-Source Leakage Current | Igss | V _{DS} =0V V _{GS} =±30V | | - | 10 | 100 | nA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =10V I _D =9.0A | | - | 0.146 | 0.160 | Ω |
| Gate resistance | RG | f=1MHz, open drain | | - | 9.8 | - | Ω |

Dynamic Ratings

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|---|---------------------|---|------|------|------|------|
| Forward Transconductance | g fs | V _{DS} =25V / _D =9.0A | 5.7 | 11.5 | - | S |
| Input Capacitance | Ciss | V _{DS} =400V | - | 990 | - | |
| Output Capacitance | Coss | V _{GS} =0V | - | 35 | - | |
| Reverse Transfer Capacitance | Crss | f=250kHz | - | 5.3 | - | |
| Effective output capacitance, energy related (Note *7) | Co(er) | V _{DS} =0400V V _{GS} =0V | - | 83 | - | pF |
| Effective output capacitance, time related (Note *8) | Co(tr) | V₀s=0400V V₀s=0V /₀=constant | - | 308 | - | |
| Turne Ore Times | t _{d(on)} | V _{DD} =400V. V _{GS} =10V | - | 19 | - | - ns |
| Turn-On Time | tr | $/_{D}=9.0A,$ | - | 63 | - | |
| | t _{d(off)} | R _s =15Ω See Fig.3 and Fig.4 | - | 87 | - | |
| Turn-On Time | rn-Off Time | | - | 23 | - | |
| Total Gate Charge | QG | | - | 43 | - | nC |
| Gate-Source Charge | Q _{GS} | V_{DD} =400V, V_{GS} =10V | - | 17 | - | |
| Gate-Drain Charge | QGD | _ /₀=17.9A See Fig.5 | - | 16 | - | |
| Drain-Source crossover Charge | Qsw | | - | 11 | - | |

Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *8 : $C_{0(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

Reverse Diode

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|-------------------------------|--------|---|------|------|------|------|
| Diode Forward On-Voltage | Vsd | <i>I</i> _{SD} =17.9A, <i>V</i> _{GS} =0V <i>T</i> _{ch} =25°C | - | 0.90 | 1.35 | V |
| Reverse Recovery Time | trr | - V₀₀=400V, /₅₀=17.9A -di/dt=100A/μs 7₅h=25°C See Fig.6 and Fig.7 | - | 285 | - | ns |
| Reverse Recovery Charge | Qrr | | - | 3.7 | - | μC |
| Peak Reverse Recovery Current | Irp | | - | 25 | - | А |

Thermal Resistance

| Parameter | Symbol | Min. | Тур. | Max. | Unit |
|--------------------|-----------|------|------|-------|------|
| Channel to Case | Rth(ch-c) | - | - | 2.778 | °C/W |
| Channel to Ambient | Rth(ch-a) | - | - | 58 | °C/W |

t=

1us

10us

100us

1ms

1000

5v

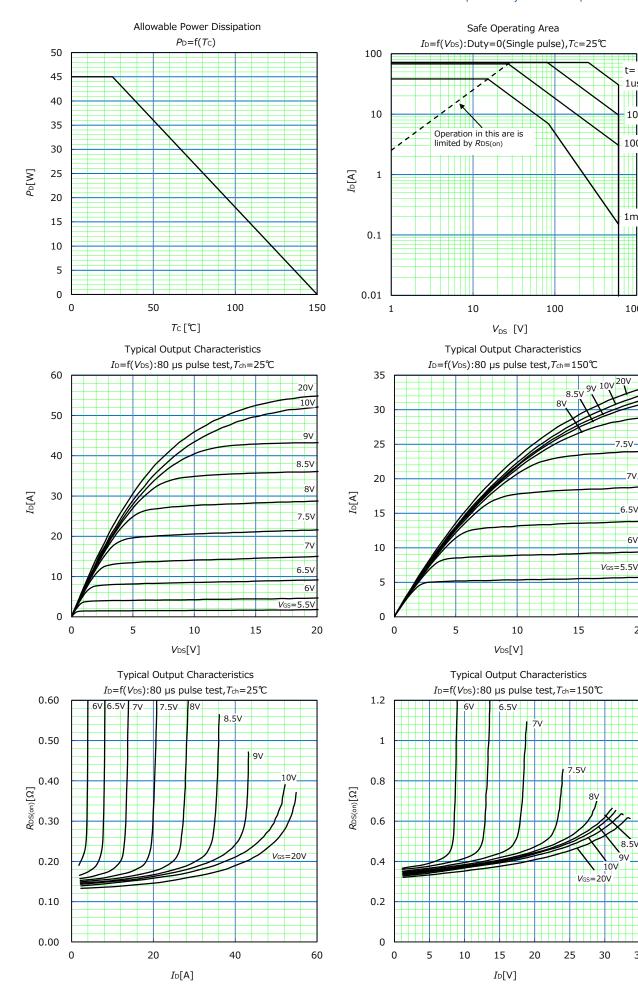
6.5

6V

20

35

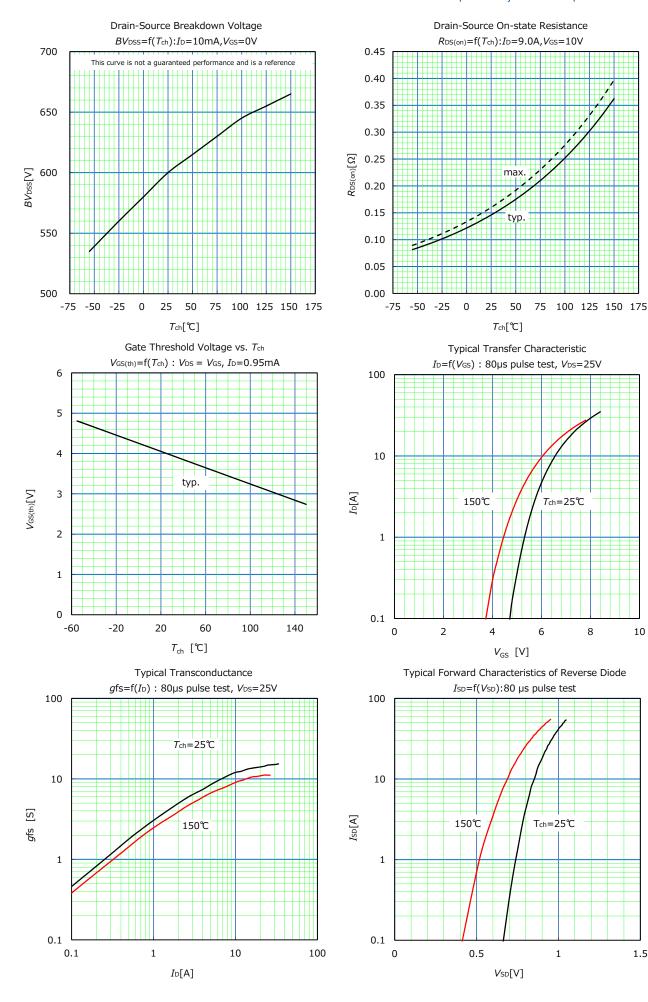
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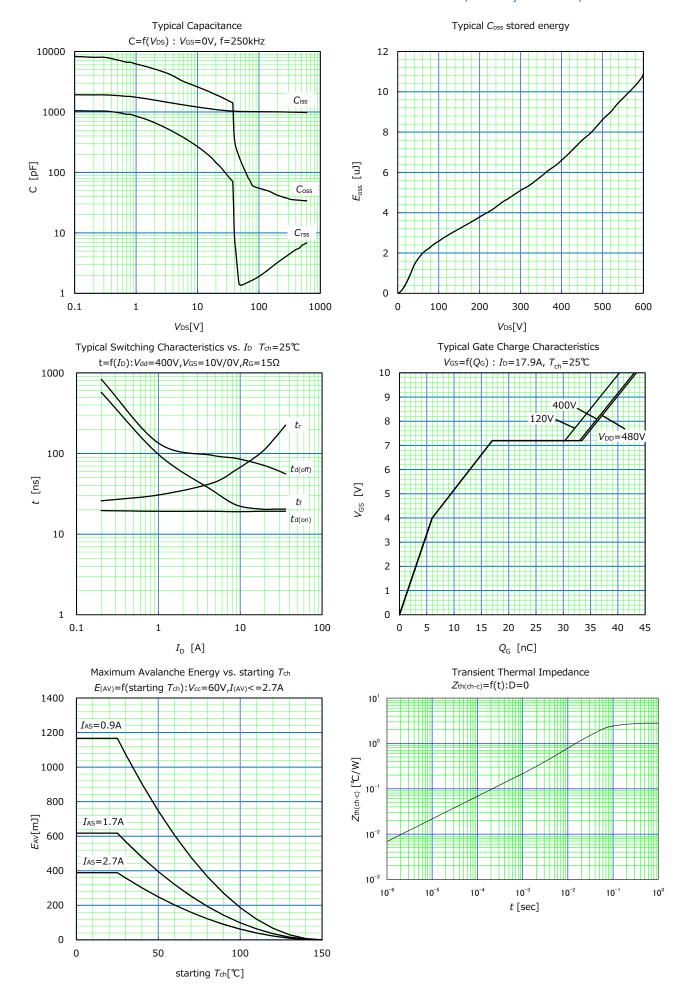
1.5

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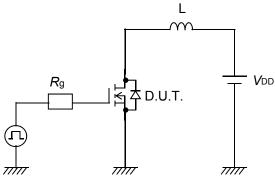


Fig.1 Avalanche Test circuit

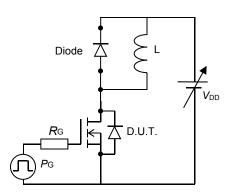


Fig.3 Switching Test circuit



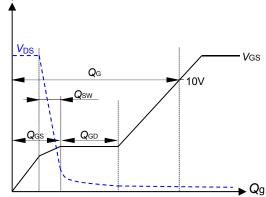
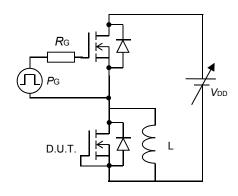
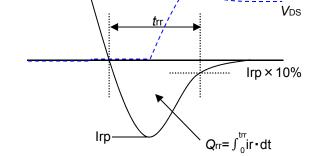


Fig.5 Operating waveform of Gate charge Test





. VDS peak

Fig.6 Reverse recovery Test circuit

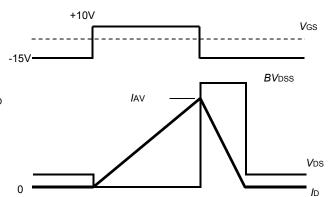


Fig.2 Operating waveforms of Avalanche Test

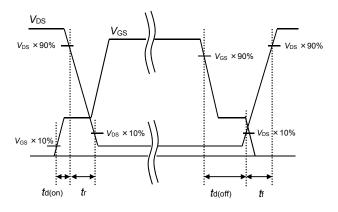


Fig.4 Operating waveform of Switching Test

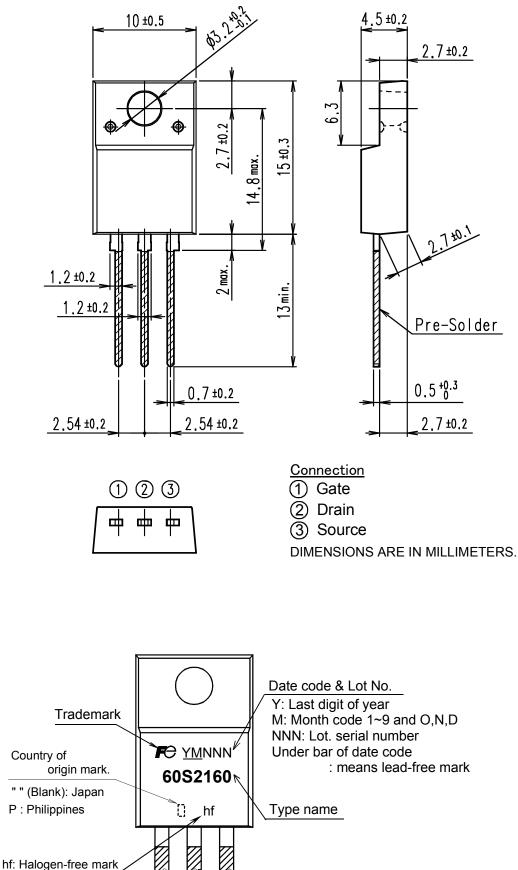
Fig.7 Operating waveform of Reverse recovery Test

Isd

Marking

http://www.fujielectric.com/products/semiconductor/

Outview: TO-220F(SLS) Package



* The font (font type,size) and the trademark-size might be actually different.

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